

Use of high performance GPUs in Aerospace and Defense applications



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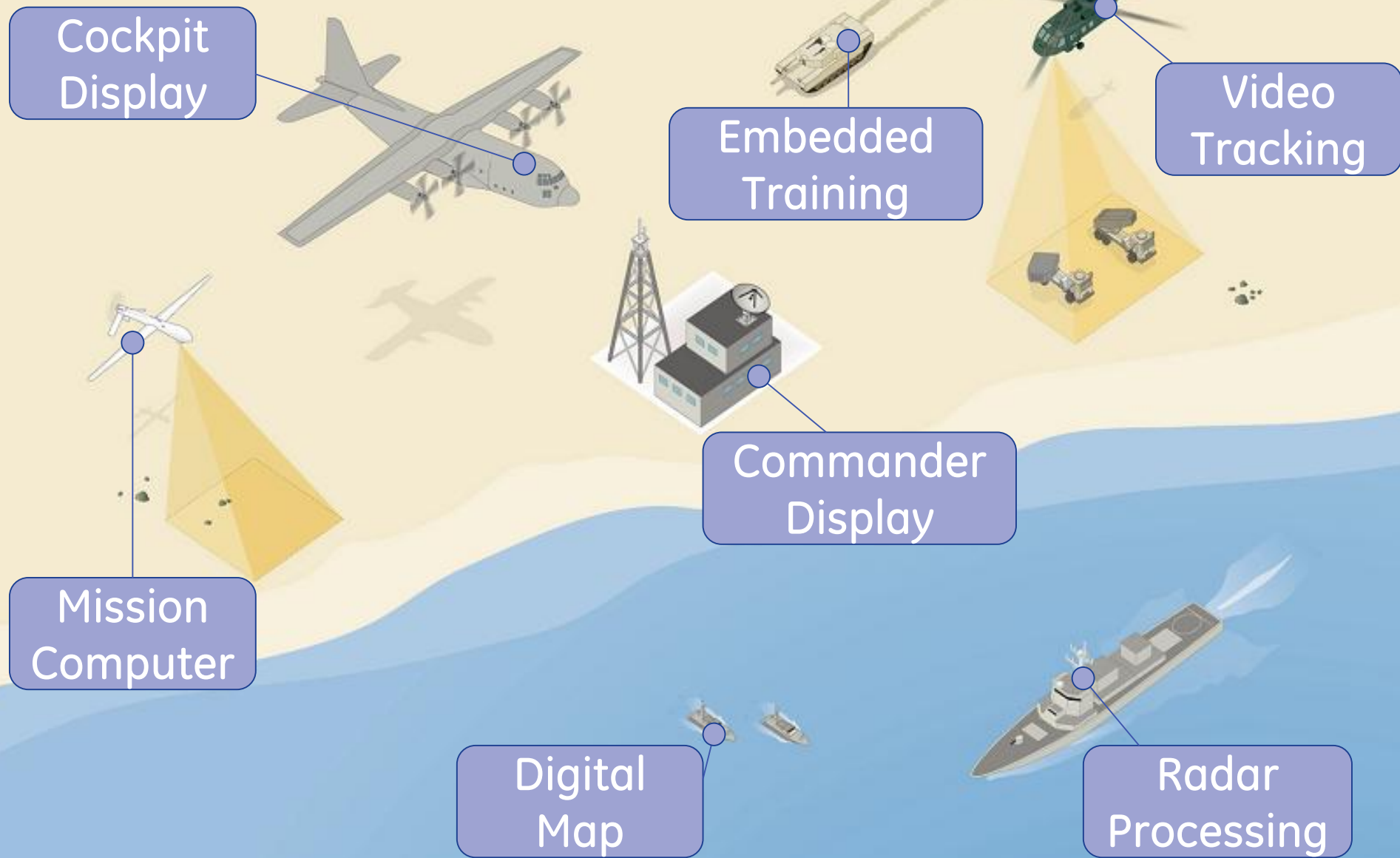
Traditional application of GPUs

Emerging applications for GPGPUs

Challenges unique to Aerospace & Defense products

Conclusion

Aerospace & Defense platforms using GPUs





Press 'H' to toggle help

DiSTI
www.simulation.com

Demo courtesy of DiSTI

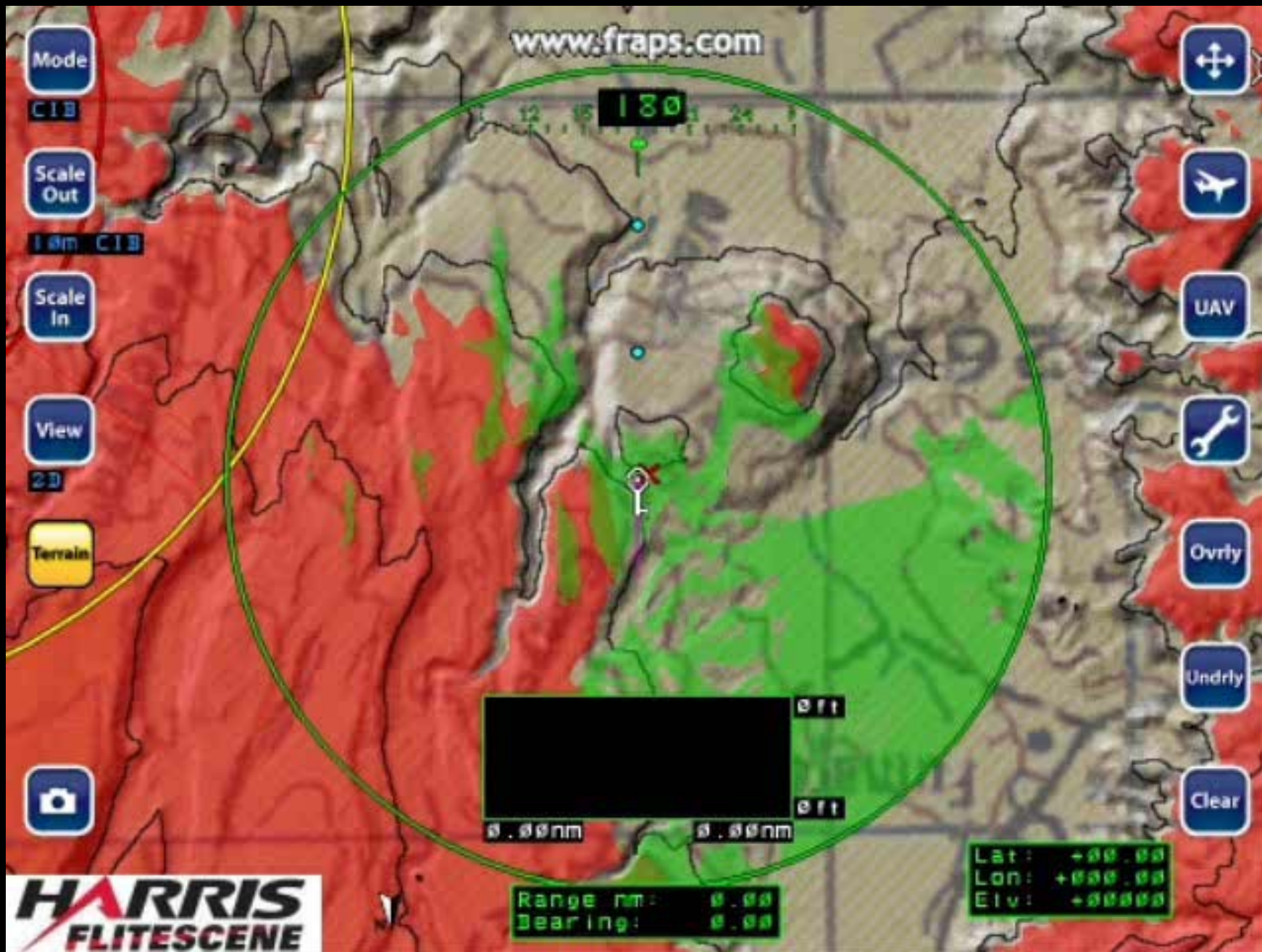
Cockpit displays

Radar displays

Cambridge Pixel
SPx



Digital mapping



Embedded Training

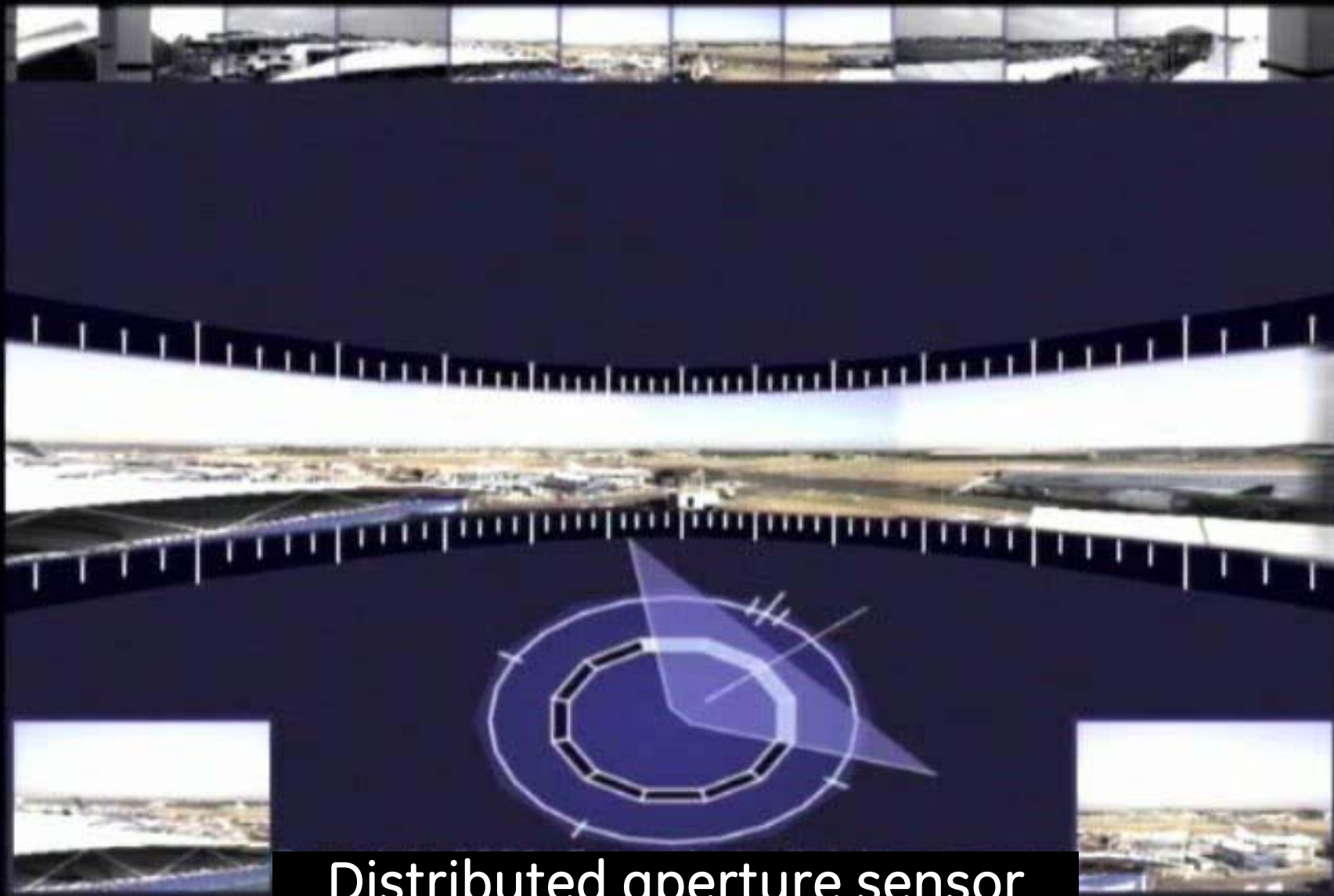
Demo courtesy of
Presagis and b.design

www.fraps.com



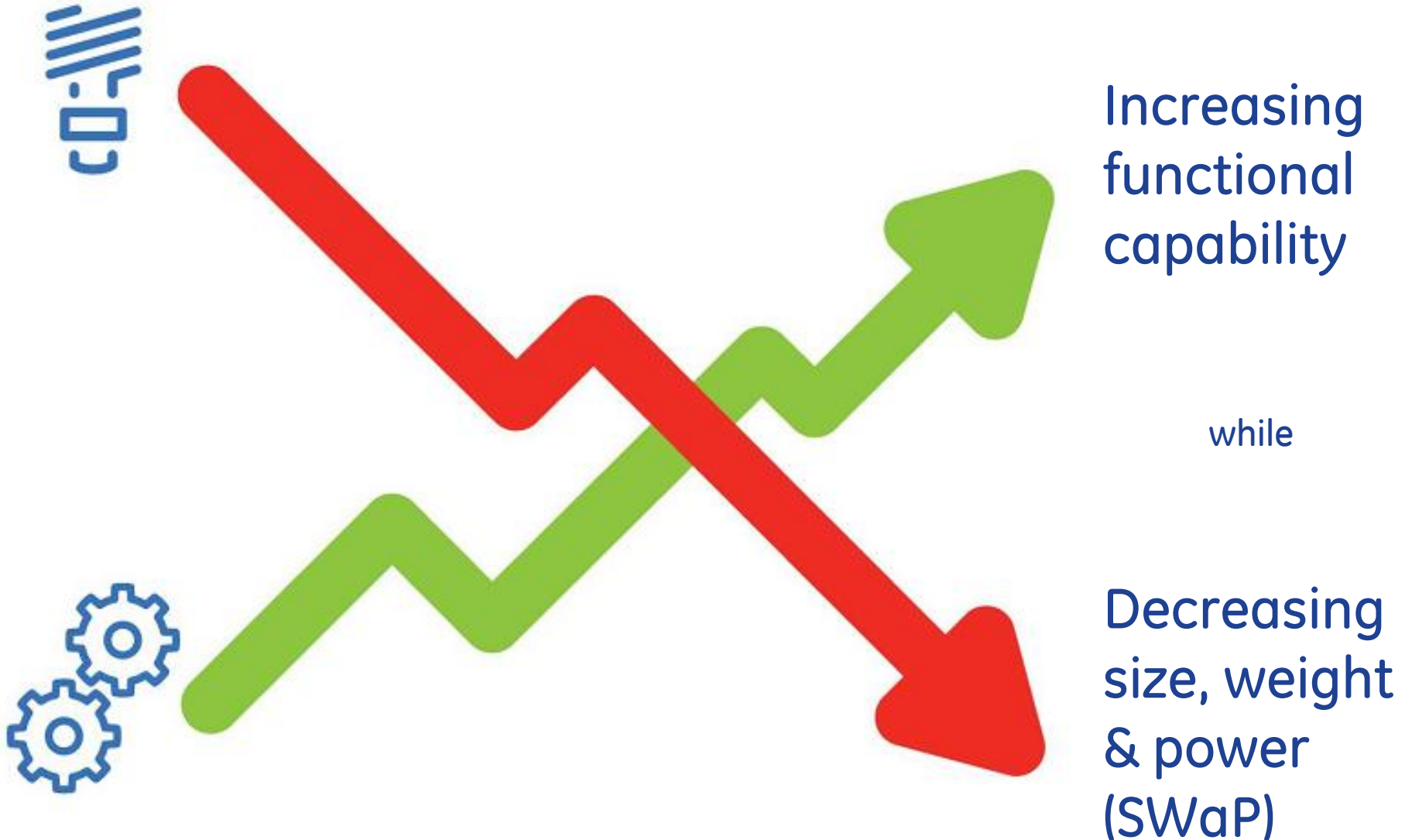
PRESAGIS

b.design



Distributed aperture sensor

Rugged GPGPU solutions



Radar processing



Typical older system:

4 cu ft., 105 lbs., 2000W

576 GFLOPS peak



New system:

0.8 cu ft., 10 lbs., 200W

574 GFLOPS peak

Video processing applications

The GPGPU will extend the range of functions that can be performed on a variety of platforms, with greater levels of autonomy

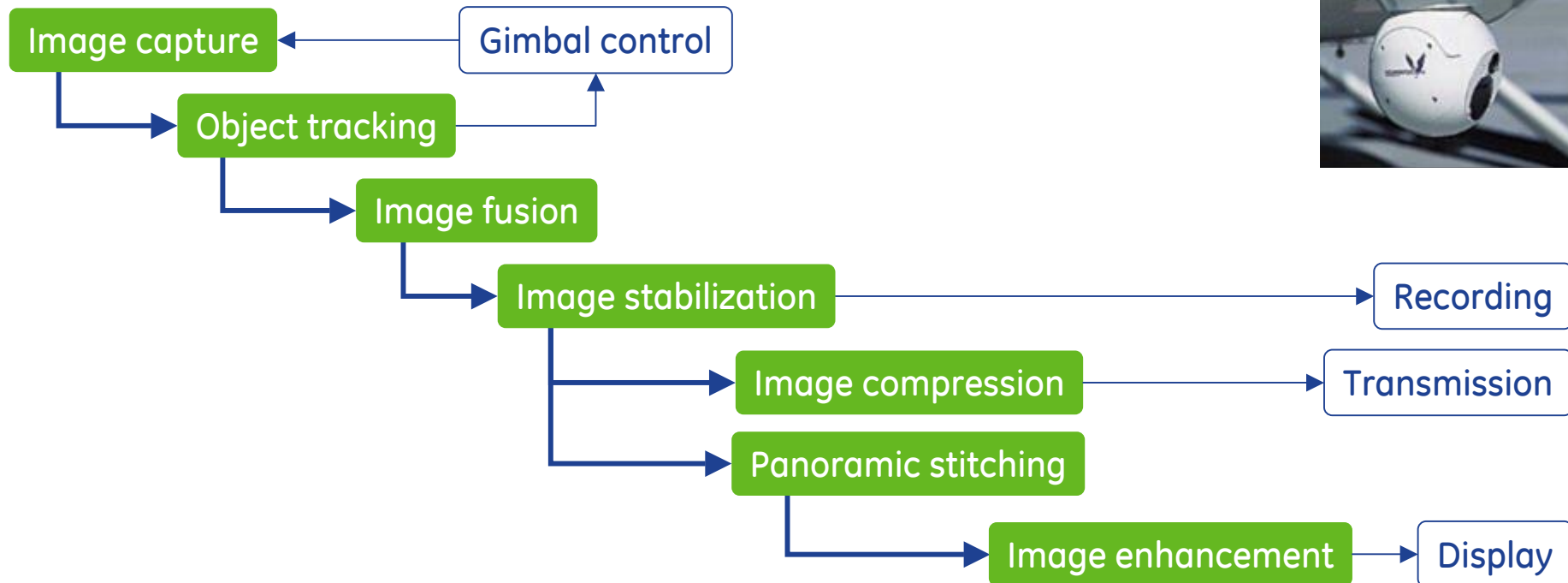




Image stabilization



ThermaCAM



ThermaCAM



What's special about A&D products?

The requirements for A&D products make regular commercial boards unsuitable

- Environment

- Configuration control

- Obsolescence management

- Long term support

Environment

A photograph of a modern tank, possibly an M1 Abrams, positioned in a snowy, wooded environment. The tank's main gun is pointed to the left. A soldier is visible in the turret. The surrounding trees are heavily covered in snow, creating a winter scene. The tank is on a snow-covered path or road.

Wide temperature range
-40°C to +85°C (-40°F to 185°F)
No air flow in many applications
Extensive thermal cycling

Boards must be designed to endure repeated

SHOCK



Boards must be designed to endure continuous

VIBRATION



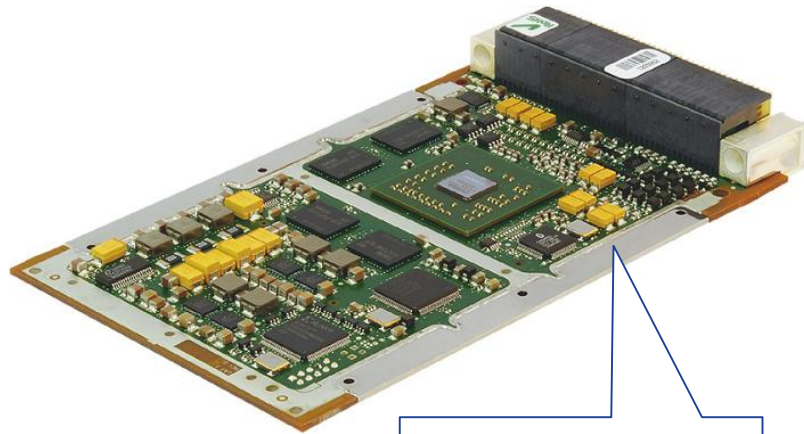
Boards must be designed to endure repeated

HUMIDITY

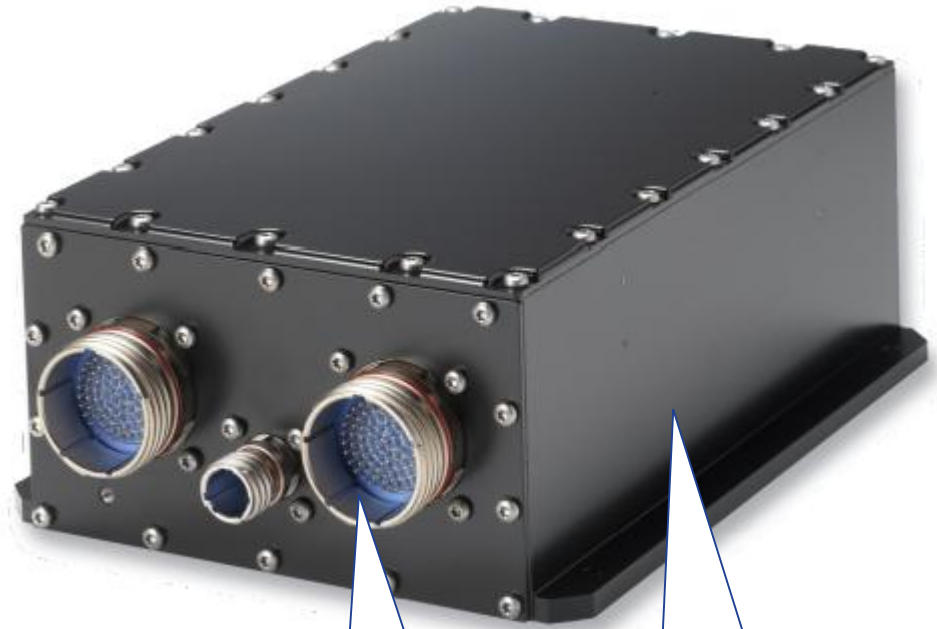
SALT FOG



Typical Aerospace & Defense products



Thermal path for
conduction cooling



Rugged MIL-STD
connectors

Hermetically sealed
enclosure



Wedgelock restraint

Configuration control



A&D platforms go through multiple phases during their lifetime

Once deployed, full component traceability is required to ensure no changes are made

GE Fanuc has teams dedicated to managing these lifecycle issues

Obsolescence management

Commercial silicon lifetimes do not support A&D deployment cycles.

Obsolescence planning is critical

- Close partnerships with silicon vendors

- Frequent “health checks” on component availability

- Storage of silicon following End of Life (EOL)

Conclusion

A&D products will always want more performance and less SWAP.

GPUs will change the A&D market.

Aerospace and Defense customers are ultimately the winners from this NVIDIA / GE Fanuc partnership.



<http://www.gefanuc.com/cuda.html>